DS92LV010A Bus LVDS Transceiver Ushers in a New Era of High-Performance Backplane Design

Bus LVDS (BLVDS) is a new family of bus interface circuits invented by National Semiconductor based on LVDS technology. This family of interface devices is optimized for multipoint cable and backplane applications. The DS92LV010A is the first member of this family and is a single transceiver device which supports operation at 155 Mbps in heavily loaded (20 Card) backplane applications. It differs from standard LVDS in providing increased drive current to handle double terminations that are required in the multi-point application. BLVDS drivers are also enhanced in their contention protection, and feature balanced output impedance.

BUS LVDS

BLVDS features a low voltage differential signal of ~250 mV and fast transition times. This allows the drivers to support applications ranging from low speeds at a few MHz (or even DC) to high speeds in the 500 MHz range and even beyond. Additionally, the low voltage swing minimizes power dissipation and noise generation. The differential data transmission scheme provides a ±1V common mode range and live insertion (hot plug) of devices into an active bus.

In the past, the bus driving problem was solved by increasing the drive current of the standard logic single-ended drivers (244 function). With standard logic swings and increased drive current, application speeds were increased to the 10 MHz - 20 MHz range, but not faster. Since increasing drive current alone was not enough, the next enhancement was made. As before, the drive current was once again raised; however, the signal swing was also reduced. Thus BTL (Backplane Transceiver Logic) was invented which supports 80 mA-sink capability and a 1V signal swing. This approach easily drives heavily loaded backplanes up to the 50 MHz - 66 MHz range. However, it is still single-ended (like generic TTL), and only provides about 400 mV of noise margin. To break the 100 MHz barrier, a single-ended, reduced swing approach is not feasible since noise margin is already at the minimum acceptable level.

Bus LVDS removes the need for a large amount of drive current, by reducing the signal swing an order of magnitude from TTL levels. With the small swing, drive current can be National Semiconductor Application Note 1115 John Goldie July 1998



reduced to 10 mA. To double the noise margin over that of the reduce-swing, single-ended technologies, BLVDS uses a differential data transmission scheme similar to LVDS but enhanced for multi-point applications. This enables the 250 mV swings to operate at 100s of Mbps, while doubling noise margin and reducing noise generation. It also supports live-insertion of devices into an active bus due to the receiver common-mode rejection capability. The first of a series of devices for BLVDS applications is the DS92LV010A. The DS92LV010A "Single Bus LVDS Transceiver" device's performance is the scope of this application.



FIGURE 1. DS92LV010A Bus LVDS Single Transceiver

THE DEVICE

The DS92LV010A is a highly versatile 8-pin compact device. It provides one line driver and one receiver with common bus pins. The common bus I/O pins reduce bus loading to a minimum (5 pF typical). The logic side of the device supports four pins for maximum flexibility. The four pins are driver input (DI), driver enable (DE) - active high, receiver output (RO), and receiver enable (RE*) - active low. The four inputs are CMOS inputs with TTL compatible thresholds. They also present high impedance in power-off conditions and will not load down the driving gate. The block diagram is shown in Figure 1. This allows the device to be configured as a driver, a receiver, or a transceiver. Both the driver and receiver functions can be enabled simultaneously to support a loop back function. Or, the DE and RE* pins may be tied together to form a direction control pin. The possible configurations are shown in Figure 2.



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The DS92LV010A may be used in standard LVDS Point-to-Point applications, Multi-drop data distribution applications, or in a classical multi-point bus application. It may be employed for use on data buses, or for clock distribution. Pointto-Point, Multi-drop, and Multi-point bus configurations are shown in *Figure 3*.



FIGURE 3. Bus Configurations: Point-to-Point, Multi-Drop, and Multi-Point

The DS92LV010A may also be powered from a 5V or a 3.3V rail directly. Respective parameters are listed separately in the datasheet. BLVDS bus characteristics and AC parameter performance is similar for either power supply operation. This allows the device to be used in a wide variety of applications.

THE DRIVER

The driver translates standard TTL levels to differential BLVDS levels. The driver output levels are nominally 1.375V and 1.125V providing a 250 mV differential signal across a 27 Ω load. The offset voltage (V_{OS}) of the driver is nominally 1.25V. When the driver input is logic high (>2V), the true out-

put is also high (BLVDS High) while the inverting output is low (BLVDS Low), thus yielding a +250 mV differential output voltage. Mathematically the differential voltage is calculated as A–B, or 1.375 – 1.125 = +250 mV. For a low driver input (<0.8V) the true output is low while the inverting output is high, thus yielding a -250 mV differential output voltage. Again, mathematically this is calculated as A–B, or 1.125 – 1.375 = -250 mV. The differential output voltage. Again, mathematically this is calculated as A–B, or 1.125 – 1.375 = -250 mV. The differential output signal swing (Vss) is twice V_{OD}, typically 500 mV with the 27 Ω load across the driver outputs. *Figure 4* illustrated the I_{OD} vs V_{OD} curve for the device when operating for a 3.3V or 5V rail. Data points are shown for 100 Ω , 90 Ω , 80 Ω , 70 Ω , 60 Ω , 50 Ω , 45 Ω , 40 Ω , 35 Ω , 30 Ω , 27 Ω , 20 Ω and 10 Ω differential loads.





FIGURE 4. I_{OD} vs V_{OD} Curves

Output impedance is balanced on the BLVDS driver. The sourcing impedance is matched to the sinking impedance. This can be seen in the slope of the respective V_{OH}/I_{OH} and V_{OL}/I_{OL} curves for the device. These curves are shown in *Figure 5*. By subtracting the V_{OL} curve from the V_{OH} curve, the differential output voltage curve can be drawn (see *Figure 4*). This curve provides V_{OD}/I_{OD} information discussed

above. Since the device has a fixed output impedance, the differential output voltage will vary depending upon the applied termination load. With a 27 Ω load, the nominal V_{OD} is 250 mV (I_{OD} = 9.4 mA). With a 100 Ω load, the nominal V_{OD} is 725 mV (I_{OD} = 7.25 mA) when the device is powered from a 3.3V rail. The single termination load to typically employed





Also plotted on the V_{OH}/I_{OD} ($I_{OH})$ and V_{OL}/I_{OD} ($I_{OL})$ is the driver offset voltage (V_{OS}). The flatness of this line is also a measure of balanced output impedance. For LVDS and BLVDS drivers, this driver offset voltage is typically 1.25V. The offset voltage is also one component of the common mode voltage at the receiver input on the bus. The active signal levels present at the receiver input is a function of four components:

- 1. The active driver offset voltage V_{OS}
- Any ground potential difference 2. between the devices — V_{GPD}
- 3. Any longitudinally coupled noise (common mode)-V_{noise}
- 4. The active driver differential output voltage V_{OD}

Mathematically this is: $V_{CM} = V_{OS} \pm V_{GPD} \pm V_{noise}$ ± 0.5V_{OD}. For LVDS and BLVDS systems, a ± 1V common mode range is typically allowed, which is around the driver offset voltage of +1.25V. Therefore the input common-mode voltage range is +125 mV to +2.375V. This assumes an offset of +1.25V, a differential voltage of 250 mV and the combination of ground potential difference (V_{GPD}) and noise (V_{Noise}) is ±1V maximum. Note, how $V_{\text{OD}}, V_{\text{OS}}$ and V_{CM} are related. Figures 6, 7 illustrate the measurement of these common data transmission parameters.



V_{CM} = V_{OS} ± V_{GPD} ± V_{Noise} ± 0.5 V_{OD}



FIGURE 7. The Three Components of V_{CM}

FAULT TOLERANT AND CONTENTION SAFE

The driver is also very fault tolerant. Being a current mode device, output current is regulated. Shorting a high output to ground results in a small fault current. Even with a logic-high output shorted to ground, fault power dissipation is limited to less than 100 mW (IOS_{MAX} x V_{CC} => 20 mA x 5V). A low driver output can also be shorted to a supply rail without excessive current or damage to the device. In this case output short current is limited to typically 15 mA, minimizing fault current power dissipation. If multiple drivers are enabled at the same time, the drivers will scale back output current until a compliance voltage is met. This prevents damage to the drivers under contention conditions that may occur due to software error, or hardware configuration. The DS92LV010A features a rugged I/O.

NOISE MINIMIZER

The '010 driver is a current mode device, and output loop current is controlled. This provides multiple benefits to the end system. First, dynamic power dissipation increases slowly as switching frequency is increased. This enables the device to operate at high data rates, easily exceeding 155 Mbps. The current mode driver also minimizes shootthrough current in the driver output stage during transitions; thus a flat $I_{\rm CC}$ vs frequency curve is obtained without a lot of noise generated on the power and ground planes of the board. Lastly, the current mode outputs provide soft transitions with less high frequency content, reducing generated EMI. Crosstalk can also be a problem in high-density applications where signal lines are closely spaced in backplane routing channels. BLVDS drivers help to reduce system crosstalk since their voltage swings are so small and crosstalk is proportional to amplitude.

HIGH IMPEDANCE BUS PINS

The bus pins (DO/RI) provide high-impedance to the bus when the device is in TRI-STATE® or powered-off. This is extremely important in multi-point applications. Communication between other active nodes should not be impacted if one or more of the devices on the bus is powered-off. The DS92LV010A supports this feature along with glitch-free bus pins on power-up and down. Until V_{CC} OK is reached, the driver output pins are held in TRI-STATE by an internal circuit. At V_{CC} -OK (typically 2.5V), the outputs follow the enables pins. If the driver enable (DE) is low out this point; the driver outputs will remain off, and will not disturb traffic on the bus while it is being powered-up. Bus loading presented by the transceiver is also minimized since small geometry devices are used in the output of the driver (10 mA). Additionally, driver output and receiver input pins are connected together internally to reduce bus loading (only two pads required instead of four). The bus pins typically present a small 5 pF load. The light loading helps to maintain a high working impedance for the bus.

AC PERFORMANCE

The DS92LV010A driver provides tight AC parameter limits to support 155 Mbps operation. Driver rise and fall times are typically 300 ps and are specified at 2 ns maximum. This supports a ratio of 1-to-3 of transition time to unit interval and provides a good balance between waveshape and noise generation. Slew rate of the driver is held to typically 1 V/ns. Also of importance is the propagation delay through the driver for system timing calculations. Propagation delay is specified at 3 ns typical and 5 ns maximum. Skew (pulse skew) is typically 200 ps, and specified to be less than 1 ns. Enable / Disable times are less than 10 ns, allowing for quick turn around on the bus. Refer to the datasheet for complete AC parameter limits, and conditions.

THE RECEIVER

The receiver is a high-gain, high-speed device. It detects differential voltages as small as 20 mV (100 mV threshold spec) and amplifies them to full CMOS levels with a propagation delay of only 5 ns. The bus pins are high impedance (greater than 200 kΩ) to minimize loading effects to the bus (see High Impedance Bus Pins – section above). The High-impedance loading to the bus pins is also presented when the device is powered-off. This allows for communication between other active nodes on the bus, while the power is off to some of the nodes. This is especially important in applications that employ multiple receiver or transceiver (multipoint) devices. The receiver output transition times are controlled to limit switching noise from disturbing the bus, and from generating system noise. The receiver's performance and features are discussed next.

RECEIVER FAILSAFE

The receiver also supports a Failsafe function. For three different input conditions, a stable HIGH output level on the receiver will be obtained. The three conditions occur due to different system configurations and events, they are:

- 1. Open Inputs
- 2. Terminated Inputs
- 3. Shorted Inputs

An "Open Inputs" condition occurs when a powered-up card or node is removed from the bus. If this node does not include the termination resistor, then the inputs are now open. Internal to the receiver, the plus input is pulled high, and the minus input is pulled low with high impedance resistive networks in the 200 k Ω range.

A "Terminated Inputs" condition occurs under multiple scenarios. This can occur when the bus is idle (no active driver), when all drivers are powered-off, or when a card is removed from the bus and it includes the termination resistor, then the inputs are "terminated". Once again, internal bias network will set the output high for these conditions. Under this condition, a small differential voltage is created, if there is differential noise, then additional external failsafe resistors may be required. Recall that the receiver is a high-gain, highspeed device, and its function is to detect small (amplitude and duration) differential pulses and amplify them to full CMOS levels. If this is the case – see the section on "External Failsafe Biasing".

"Shorted Inputs" condition occurs when the "plus" input is shorted to the "minus" input and the resulting differential voltage is 0V. Shorted input failsafe is not supported across the common mode range of the receiver. It is defined as the input pins "shorted" together and no external common mode voltage applied. It is typically not a good approach to pull both inputs to the same common mode point also. This can cause distortion to the first driven bit of valid data when the bus becomes active.

External Failsafe Bias resistors can be used to boost the failsafe protection in noisy applications. The external bias resistors should be an order of magnitude greater than the termination resistor to minimize loading effects to active drivers. The common mode point should be set to the 1.2V - 1.5V range, and for the DS92LV010A should be always below 1.7V (see datasheet).

COMMON MODE RANGE

The receiver detects differential voltages, and rejects common mode voltages. The input stage design of the receiver is optimized for switching performance over the common mode range. This is the minimum common mode range of the device (GND to +2.4V). Input voltages may be up to one diode below ground, and also as high as one diode above the device's V_{CC} potential. Exceeding this range may forward bias the ESD protection circuitry of the device and clamping of the active signal. The three components of the common mode voltage seen at a receiver input are shown in Figure 7. Noise coupled equally onto both lines is shown in Figure 8. This noise is seen in the single-ended waveforms and not in the differential waveform (A-B). To preserve the common mode rejection of the receiver, twisted-pair cable and closely coupled differential traces should be used as interconnect. This will help ensure that noise is coupled equally to both lines, and will be seen as common-mode and rejected.





AC PERFORMANCE

The DS92LV010A receiver like the driver provides tight AC parameter limits to support 155 Mbps operation. Propagation delay through the receiver for system timing calculations is specified at 5 ns typical and 12 ns maximum. Skew, or pulse skew is typically 500 ps, and specified to be less than 2 ns. The receiver's rise and fall times are typically 1.5 ns and are specified at 4.0 ns maximum. Transition times are smooth and balanced through the use of graduated turn-on circuitry. This provides a symmetrical waveshape and generates little noise. Enable/Disable times are less than 13 ns, allowing for quick turn around on the bus. Refer to the datasheet for complete AC parameter limits, and conditions.

BACKPLANE BENEFITS

The DS92LV010A is a highly versatile transceiver designed to deliver Megabits @ millwatts. The concept of BLVDS and differential data transmission also improves many aspects of system design. These topics are discussed next briefly, and are the subject of other National Bus LVDS application notes.

COMMON SUPPLY RAILS

Unlike other high-performance technologies, the DS92LV010A Bus LVDS Single Transceiver is powered from common logic power rails of 5V or 3.3V. ECL is also a high-performance technology, but requires unique supply rails such as –5.2V ECL or ±2.5V for split-rail ECL operation. These unique rails may complicate system power generation and distribution. They also complicate the task of interfacing directly to standard logic devices and other non-ECL application specific devices (ASICs).

PASSIVE TERMINATION SIMPLIFIES BACKPLANE, ELIMINATES ACTIVE DEVICES, AND IMPROVES RELIABILITY!

BLVDS eliminates the need for a special termination pull-up rail (V_t). Again this simplifies system power generation and termination voltage distribution. It eliminates the need for active termination devices commonly required by the open-collector/drain single-ended technologies. This reduction in termination complexity improves system reliability, and saves PCB space.

LIVE INSERTION SUPPORT

The differential transmission scheme supports live insertion of cards into active busses. This is due to the fact that when a card is plugged into the bus the resulting glitch is seen as common mode and ignored by active receivers. The driver also includes a glitch-free power up circuit that keeps the driver outputs in high-impedance until powered-up and enabled. To ensure power biasing of the devices, standard power sequencing is recommended. Ground should be applied first, then power, and then I/O pins on insertion. For removal, the reverse order is recommended.

BLVDS ACHIEVES MEGABITS @ MILLIWATTS!

BLVDS drivers are capable of operating at 100's of Mbps in heavily loaded backplane applications. The data throughput is achieved by the combination of differential data transmission and a small signal swing. However, not only is Megabit service provided by BLVDS, but also ultra low power dissipation is provided. This is gained by the use of a core submicron CMOS process, a current mode driver and also the small signal swing. With these low power levels, standard IC packaging may be employed, and also the integration of digital blocks is enabled. The DS92I V1021/1210 Bus I VDS Serializer / Deserializer is an example of integration that BLVDS has enabled. These devices include the BLVDS PHY (Line Driver, Receiver, or Transceiver functional block), and also the serial-parallel / parallel-serial conversion, clock embedding, clock recovery functions and digital control circuitry all in a 28L SSOP package. These devices operate at 400 Mbps, and together consume typically less than 250 mW of power (at maximum switching rate).

SUMMARY

The DS92LV010A is the first of a series of devices for highspeed multi-point applications. The device can operate in the 100 Mbps – 155 Mbps range while consuming minimal power and directly interface with standard logic devices. The Bus LVDS products provide designers with new alternatives for solving high-speed multipoint bus interface problems.

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	National Semiconductor	National Semiconductor	National Semiconductor	National Semiconducte
\mathbf{N}	Corporation	Europe	Asia Pacific Customer	Japan Ltd.
V	Americas	Fax: +49 (0) 1 80-530 85 86	Response Group	Tel: 81-3-5620-6175
	Tel: 1-800-272-9959	Email: europe.support@nsc.com	Tel: 65-2544466	Fax: 81-3-5620-6179
	Fax: 1-800-737-7018	Deutsch Tel: +49 (0) 1 80-530 85 85	Fax: 65-2504466	
	Email: support@nsc.com	English Tel: +49 (0) 1 80-532 78 32	Email: sea.support@nsc.com	
		Français Tel: +49 (0) 1 80-532 93 58		
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